

Connecticut Science Fair Association, Inc.
Form 1D - Release Required with Registration

Name _____ School _____ Town _____
(Submit a release for each team member.)

Liability for Exhibits & Risks of Research Plan

Since the exhibition of projects at the Connecticut Science & Engineering Fair is open to the public, The Connecticut Science Fair Association, Inc., and its committees cannot and will not accept any liability or responsibility of any nature for any theft of, or loss or damage to, any Exhibit or any other property of any Exhibitor. There is no need for any equipment of value to be part of the exhibit. During final judging when equipment may be displayed each Exhibitor should secure and guard his/her Exhibit and/or other property at all times.

I have read the Research Plan prepared by my child and understand the risks and possible dangers involved in the research anticipated.

I understand and accept that the Connecticut Science & Engineering Fair cannot and will not accept any liability or responsibility for theft, damage, or risk and possible danger involved in my or my child's participation in this activity.

Research Ethics

I have read and will abide by the Connecticut Science & Engineering Fair ethics statement. I recognize that my failure to abide by the ethics statement may result in my disqualification in the Fair and possible exclusion from future Fairs.

Publicity

The Connecticut Science & Engineering Fair is a statewide event, and your participation is newsworthy. The organizations or businesses sponsoring awards at the fair may want to publicize their involvement in such an important science competition by using photographs or information about you. Your cooperation may make it possible for other promising young students to get involved in science and engineering.

You have my permission to use appropriate information about me for publicity purposes. This includes photography submitted by me as well as any photographs, videos or likenesses that may be used by the Connecticut Science & Engineering Fair, its grant sponsors or the sponsors of awards for the purposes of illustration, advertising or publication in any manner. I also consent to the use of my name in connection therewith.

By providing and printing our names and contact information, we accept the terms of this release.

Student Name / Date

Parent/Legal Guardian Name / Date

Relationship

Email / Phone Number